# 146280-2 ~ ACTIVE

#### AMPMODU | AMPMODU Headers

TE Internal #: 146280-2 PCB Mount Header, Vertical, Board-to-Board, 2 Position, .1 in [2.54 mm] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 2

Number of Rows: 1

### Features

#### Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Connector Contact Load Condition	Fully Loaded				
PCB Mount Orientation	Vertical				
Number of Positions	2				
Number of Rows	1				
Board-to-Board Configuration	Parallel				
Body Features					
Primary Product Color	Black				
Contact Features					
Mating Square Post Dimension	.64 mm[.025 in]				
	10 – 20 µin				
Contact Shape & Form	Square				
Contact Underplating Material	Nickel				

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PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
ermination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.05 mm[.12 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
lechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
lousing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)
Dimensions	
PCB Thickness (Recommended)	1.6 mm[.063 in]
Jsage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	
	Signal
ndustry Standards	Signal
<mark>ndustry Standards</mark> Approved Standards	Signal CSA LR7189, UL E28476
Approved Standards	CSA LR7189, UL E28476
Approved Standards UL Flammability Rating	CSA LR7189, UL E28476

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## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant		
EU ELV Directive 2000/53/EC	Not Compliant		
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold		
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Pb (13% in Component Part) Aticle Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.		
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free		
Solder Process Capability	Reflow solder capable to 260°C		

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

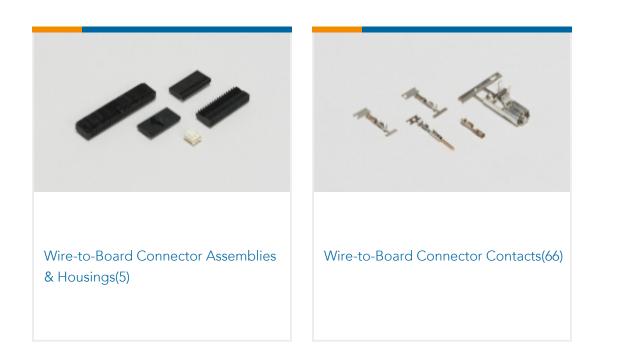
chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

## Also in the Series AMPMODU Headers



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## Customers Also Bought



RN 0805 1K78 0.1% 10PPM 1KRL	RN 0805 2K05 0.1% 10PPM 1KRL	SPLICE BUTT PIDG 16-14	SHUNT, ECON, PHBR 5AU, BLACK



TE Part #985923J001 V2-6.0-0-SP-SM

## Documents

Product Drawings 02 MODII HDR SRST B/A .100CL

English

**CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_146280-2\_D.2d\_dxf.zip

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English

Customer View Model ENG\_CVM\_CVM\_146280-2\_D.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_146280-2\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU Interconnetion System

AMPMODU Interconnetion System

English